CH

RoHS

COMPLIANT

HALOGEN

GREEN

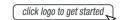
(5-2008)

# High Frequency 50 GHz Thin Film Chip Resistor



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## **DESIGN SUPPORT TOOLS**



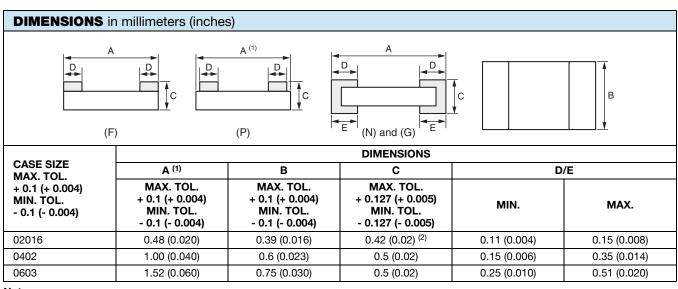
**3D** Models Available

Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz.

## FEATURES

- Operating frequency 50 GHz
- Thin film microwave resistors
- SMD wraparound or flip chip resistor
- Small size, down to 20 mils by 16 mils
- Edged trimmed block resistors
- Pure alumina substrate (99.5 %)
- Ohmic range: 10R to 500R
- Design kits available
- Small internal reactance (LC down to 1 × 10<sup>-24</sup>)
- Tolerance 1 %, 2 %, 5 %, 10 %
- TCR: 100 ppm/°C in (-55 °C, +155 °C) temperature range
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

STANDARD ELECTRICAL SPECIFICATIONS						
MODEL	SIZE	RESISTANCE RANGE Ω	RATED POWER Pn W	LIMITING ELEMENT VOLTAGE V	TOLERANCE ± %	TEMPERATURE COEFFICIENT ± ppm/°C
CH02016	02016	10 to 500	0.030	30	2, 5, 10	100
CH0402	0402	10 to 500	0.050	37	1, 2, 5, 10	100
CH0603	0603	10 to 500	0.125	50	1. 2, 5, 10	100



#### Notes

<sup>(1)</sup> For CH0402 and CH0603 with P termination, A dimension is increased by 0.2 mm

(2) + or - 0.07 mm

Revision: 17-Nov-17

1

Document Number: 53014

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LAND PATTERN FLIP CHIP TERMINATIONS in millimeters			
	G <sub>n</sub> Z <sub>max.</sub>	/ / v	nax.
CHIP SIZE	Z <sub>max.</sub>	X <sub>max.</sub>	G <sub>min.</sub>
02016	0.53	0.44	0.15
0402	1.4	0.650	0.4
0603	1.71	0.9	0.760

Note

Suggested land pattern: According to IPC-7351

COMPONENT

Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard"

Example of land pattern: Fabrication allowance, assembly location and min. or max. level density board are not included in the exemple bellow.

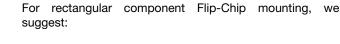
According to IPC-7351A "Generic Requirements for Surface Mount Design and Land Pattern Standard":

 $Z_{max.} = A_{min.} + 2J_T + \sqrt{(C_A^2 + F^2 + P^2)}$  with C: "Unilateral profile tolerance for the component";

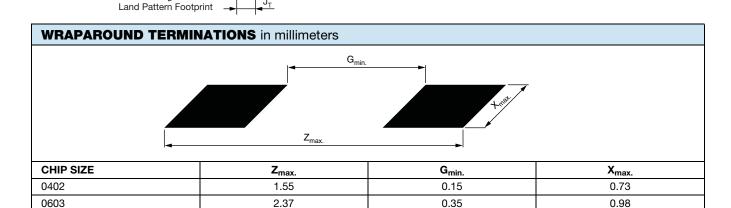
J<sub>T</sub>

 $G_{min.} = F_{max.} + 2J_H - \sqrt{(C_F^2 + F^2 + P^2)}$  F: "Unilateral profile tolerance for the board land pattern";

 $X_{max.} = B_{min.} + 2J_S + \sqrt{(C_B^2 + F^2 + P^2)}$  and P: "Diameter of true position placement accuracy to the center of land pattern".



JT (TOE)	0 mm
JH (HELL)	0 mm
JS (SDE)	0 mm



TOLERANCE VS. OHMIC VALUES			
10 $\Omega \leq R <$ 50 $\Omega$	50 $\Omega \leq R < 100 \Omega$	$100 \ \Omega \le R \le 500 \ \Omega$	
5 %, 10 %	2 %, 5 %, 10 %	1 %, 2 %, 5 %, 10 % <sup>(1)</sup>	
	10 $\Omega \leq R <$ 50 $\Omega$	10 Ω ≤ $R$ < 50 Ω	

#### Note

<sup>(1)</sup> 1 % tolerance not applicable for case 02016

Revision: 17-Nov-17





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## **PREFERRED MODELS AND VALUES**

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances.

#### Recommended Values:

10R/18R/25R/50R/75R/100R/150R/180R/200R/250R/330R/500R

Those values are available with a MOQ of 100 pieces.

Other values can be ordered upon request, but higher MOQ will apply: 1000 pieces for CH02016, 500 pieces for CH0402, 50 pieces for CH0603.

Recommended terminations:

F

Recommended tolerance:

2 %

**Design kits** are available Ex Stock in CH02016 and CH0402 sizes. There are 20 pieces per recommended value. F termination. 5 % tolerance.

Those kits are packaged in pieces of tape and delivered in ESD bags.

## PACKAGING

Standard packaging is waffle pack for sizes 0402 and 0603 and plastic tape and reel (low conductivity) for size 02016. Paper tape and reel is available for size 0402 and either paper tape and reel or plastic tape and reel (low conductivity) for size 0603.

Depending on the type of terminations, parts will be packed differently:

One face:

- Gold terminations: Active face up
- Tin/silver termination: Active face down

#### Note

• Please refer to Vishay Sfernice Application Note "Guidelines for Vishay Sfernice Resistive and Inductive Products" for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies

		NUMBE			
SIZE	MOQ	WAFFLE PACK 2" X 2"	TAPE AND REEL		TAPE WIDTH
			Min.	Max.	
02016	See MOQ mentioned	484			
0402	on preferred models	100	100	5000	8 mm
0603	and values	100			

## **PACKAGING RULES**

#### Waffle Pack

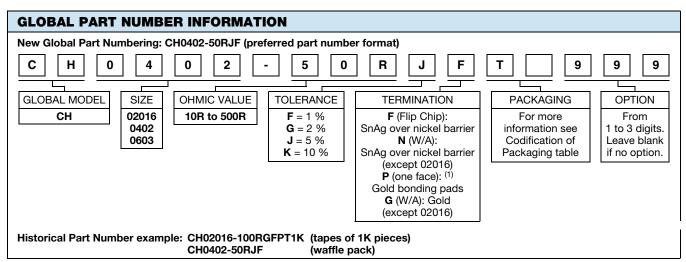
Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover. To get "not stacked up" waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

### **Tape and Reel**

See Part Numbering information to get the quantity desired by tape.



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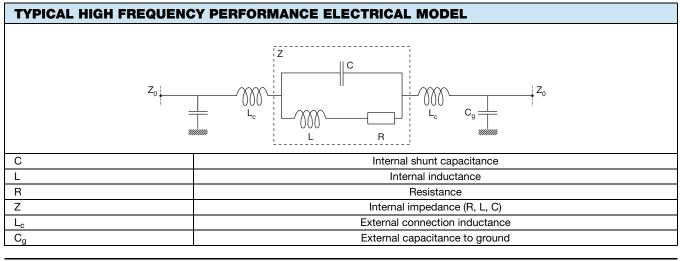


#### Notes

· Historical part numbers are not recommended but can still be used for ordering

<sup>(1)</sup> Gold termination for application in hermetic package

CODIFICATION OF PACKAGING WAFFLE PACK (standard packaging for CH0402 and CH0603)				
PLASTIC TAPE (standard pa	ckaging for CH02016 and CH0603)			
Т	100 min., 1 mult			
ТА	100 min., 100 mult			
ТВ	250 min., 250 mult			
тс	500 min., 500 mult			
TD	1000 min., 1000 mult			
TE	2500 min., 2500 mult			
TF	Full tape (qunatity depending on size of chips)			
PAPER TAPE (standard pac	kaging for CH0402 - available for CH0603)			
PT	100 min., 1 mult			
PA	100 min., 100 mult			
PB	250 min., 250 mult			
PC	500 min., 500 mult			
PD	1000 min., 1000 mult			
PE	2500 min., 2500 mult			
PF	Full tape (quantity depending on size of chips)			



Revision: 17-Nov-17

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The complex impedance of the chip resistor is given by the following equations:

$$Z = \frac{R + j\omega(L - R^{2}C - L^{2}C\omega^{2})}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]}$$
$$\frac{[Z]}{R} = \frac{1}{1 + C[(R^{2}C - 2L)\omega^{2} + L^{2}C\omega^{4}]} \times \sqrt{1 + \left[\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}\right]^{2}}$$
$$\theta = \tan^{-1}\frac{\omega(L - R^{2}C - L^{2}C\omega^{2})}{R}$$

Notes

ω = 2 x π x f
 f: Frequency

The chip resistor itself is purely resistive when  $R = \sqrt{\frac{L}{C}}$ . The smaller the L x C product the greater the frequency range over which the resistor looks approximately resistive.

This can be seen on the graphs showing the ratio  $\frac{[Z]}{R}$  versus frequency.

R, L and C are relevant to the chip resistor itself.

 $L_c$  and  $C_g$  also depends on the way the chip resistor is mounted.

It is important to notice that after assembly the external reactance of  $L_c$  and  $C_g$  will be combined to internal reactance of L and C. This combination can upgrade or downgrade the HF behavior of the component.

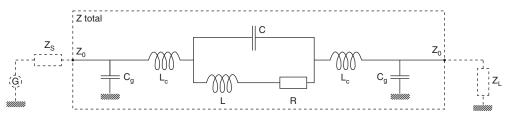
This is why we are displaying two sets of data:

•  $\left\lfloor \angle \right\rfloor$  versus frequency curves which aims to show at a glance the intrinsic HF performance of a given chip resistor

•  $\frac{R}{R}$  versus frequency curves relevant to chip resistor when assembled on ideal Z0 impedance transmission line

These lines are terminated with adapted source and load impedance respectively  $Z_s$  and  $Z_l$  with  $Z_0 = Z_L = Z_s$  (for others configurations please consult us).

Equivalent circuit for S-parameters:



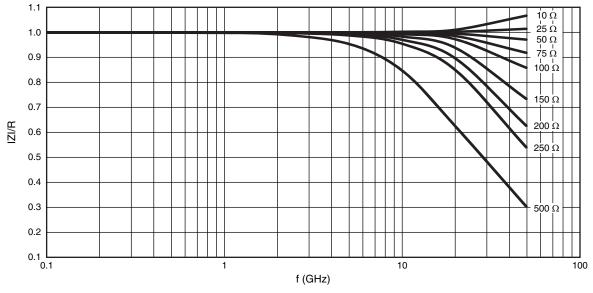
S-parameters are computed taking into account all the resistive, inductive and capacitive elements (Z total) and  $Z_0 = Z_L = Z_s = R$ .



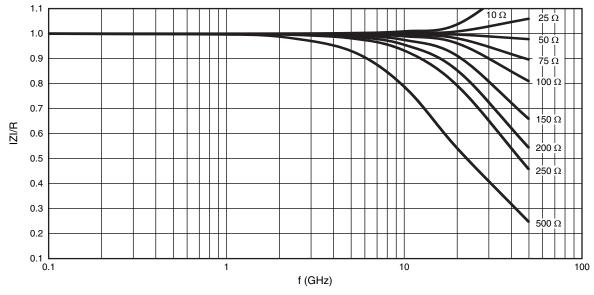
## **INTERNAL IMPEDANCE CURVES**

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Internal impedance curve for 02016 size (F and P terminations)



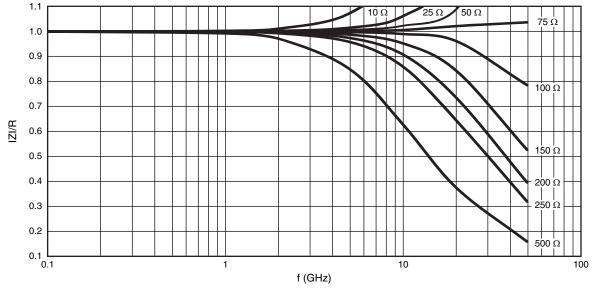
Internal impedance curve for 0402 size (F and P terminations)



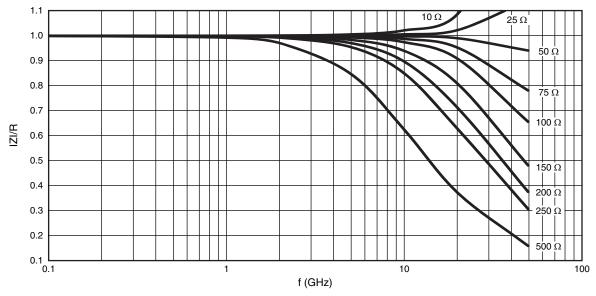
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Internal impedance curve for 0402 size (N and G terminations)



Internal impedance curve for 0603 size (F and P terminations)

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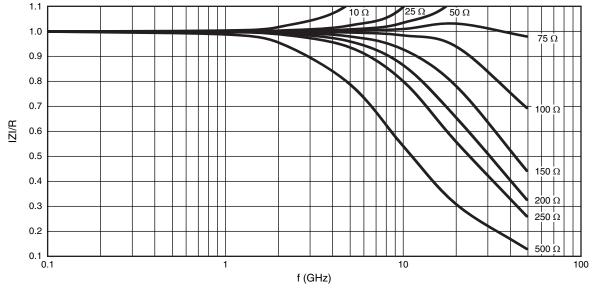
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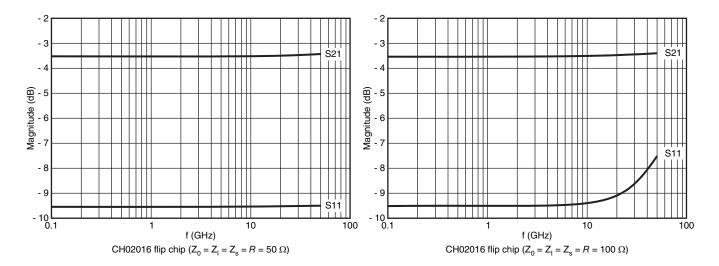
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Internal impedance curve for 0603 size (N and G terminations)

## S-PARAMETER

CH02016 (F and P Terminations)

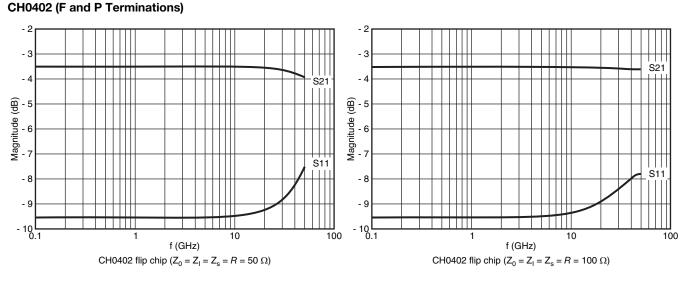


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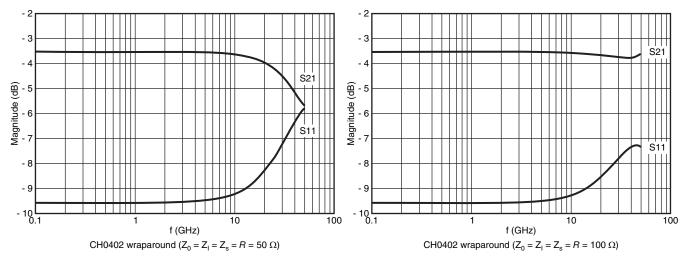


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**S-PARAMETER** 

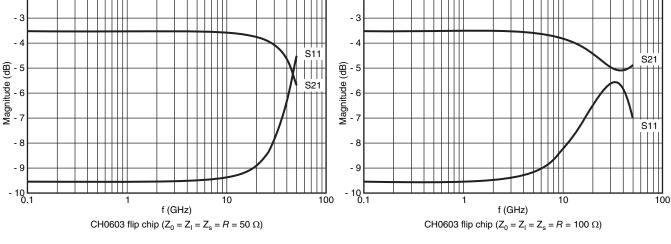


CH0402 (N and G Terminations)





CH0603 (F and P Terminations)



2

Revision: 17-Nov-17

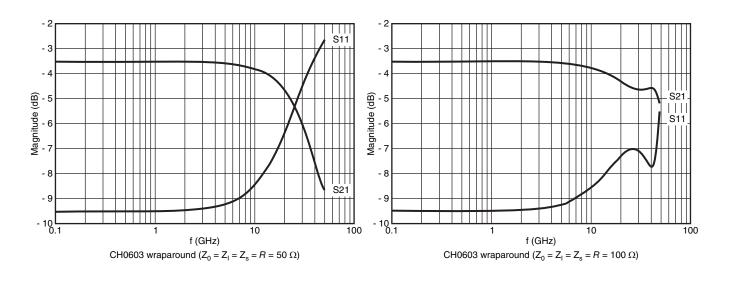
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S-PARAMETER CH0603 (N and G Terminations)



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